

Excellent Integrated System Limited

Stocking Distributor

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Fairchild Semiconductor FDH600_T50R

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Discrete POWER & Signal **Technologies**

FDH / FDLL 600





THE PLACEMENT OF THE EXPANSION GAP HAS NO RELATIONSHIP TO THE LOCATION OF THE CATHODE TERMINAL

COLOR BAND MARKING DEVICE 1ST BAND 2ND BAND

High Conductance Ultra Fast Diode

Sourced from Process 1R. See MMBD1201-1205 for characteristics.

Absolute Maximum Ratings*

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
W _{IV}	Working Inverse Voltage	50	V
Io	Average Rectified Current	200	mA
I _F	DC Forward Current	400	mA
İf	Recurrent Peak Forward Current	600	mA
İ _{f(surge)}	Peak Forward Surge Current Pulse width = 1.0 second Pulse width = 1.0 microsecond	1.0 4.0	A A
T _{stg}	Storage Temperature Range	-65 to +200	°C
TJ	Operating Junction Temperature	175	°C

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

1) These ratings are based on a maximum junction temperature of 200 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics TA = 25°C unless otherwise noted

Symbol	Characteristic	Max	Units
		FDH/FDLL 600	
P_D	Total Device Dissipation	500	mW
	Derate above 25°C	3.33	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	300	°C/W



High Conductance Ultra Fast Diode

(continued)

Electrical Characteristics TA = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Max	Units
B _V	Breakdown Voltage	$I_R = 5.0 \mu\text{A}$	75		V
I _R	Reverse Current	V _R = 50 V V _R = 50 V, T _A = 150°C		100 100	nA μA
V _F	Forward Voltage	$I_{F} = 1.0 \text{ mA}$ $I_{F} = 10 \text{ mA}$ $I_{F} = 50 \text{ mA}$ $I_{F} = 100 \text{ mA}$ $I_{F} = 200 \text{ mA}$		650 790 860 920 1.0	mV mV mV mV
Co	Diode Capacitance	V _R = 0, f = 1.0 MHz		2.5	pF
T _{RR}	Reverse Recovery Time	$I_F = I_R = 10 \text{ mA}, I_{rr} = 1.0 \text{ mA},$ $R_L = 100 \Omega$ $I_F = I_R = 200 \text{ mA}, I_{rr} = 20 \text{ mA},$ $R_I = 100 \Omega$		4.0 6.0	nS nS



Distributor of Fairchild Semiconductor: Excellent Integrated System Limited Datasheet of FDH600_T50R - DIODE GEN PURP 50V 200MA DO35

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Definition of Terms

Datasheet Identification	Product Status	Definition
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